



ISO 179/1eU

ISO 179/1eA

ISO 179/1eA

ISO 2039-1

### HOSTAFORM® C 9021 AW

#### **HOSTAFORM®**

Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988- POM-K, M-GNS, 03-002 POM copolymer Injection molding type with special additive modified; good chemical resistance to solvents, fuel and strong alkalis as well as good hydrolysis resistance; high resistance to thermal and oxidative degradation; good wear properties and low coefficient of friction. UL-registration in natural and black and a thickness more than 1.5 mm as UL 94 HB. Burning rate ISO 3795 and FMVSS 302 < 100 mm/min for a thickness more than 1 mm. Ranges of applications: sliding parts for window lifter. UL = Underwriters Laboratories (USA) FMVSS = Federal Motor Vehicle Safety Standard (USA)

Product information Resin Identification Part Marking Code	POM >POM<		ISO 1043 ISO 11469
Rheological properties			
Melt volume-flow rate Temperature Load	8 190 2.16		ISO 1133
Moulding shrinkage, parallel Moulding shrinkage, normal	2.1 <sup>[1]</sup> 1.9 <sup>[1]</sup>	%	ISO 294-4, 2577 ISO 294-4, 2577
[1]: @ 195°C			
Typical mechanical properties			
Tensile modulus	2600	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	58	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	8	%	ISO 527-1/-2
Nominal strain at break	20	%	ISO 527-1/-2
Flexural modulus		MPa	ISO 178
Tensile creep modulus, 1h		MPa	ISO 899-1
Tensile creep modulus, 1000h		MPa	ISO 899-1
Charpy impact strength, 23°C	150	kJ/m <sup>2</sup>	ISO 179/1eU

#### Poisson's ratio [C]: Calculated

#### Thermal properties

Charpy impact strength, -30°C

Charpy notched impact strength, 23°C

Charpy notched impact strength, -30°C

Ball indentation hardness, H 358/30

Melting temperature, 10°C/min	166 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	88 °C	ISO 75-1/-2
Coefficient of linear thermal expansion	110 E-6/K	ISO 11359-1/-2

130 kJ/m<sup>2</sup>

6 kJ/m<sup>2</sup>

5 kJ/m<sup>2</sup>

140 MPa

0.38<sup>[C]</sup>

#### (CLTE), parallel Flammability

Burning Behav. at 1.5mm nom. thickn.	HB class	IEC 60695-11-10
Thickness tested	1.5 mm	IEC 60695-11-10
Burning Behav. at thickness h	HB class	IEC 60695-11-10
Thickness tested	3 mm	IEC 60695-11-10
UL recognition	yes	UL 94

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#### Electrical properties

Relative permittivity, 100Hz	3.8	IEC 62631-2-1
Relative permittivity, 1MHz	3.8	IEC 62631-2-1
Dissipation factor, 100Hz	20 E-4	IEC 62631-2-1
Dissipation factor, 1MHz	50 E-4	IEC 62631-2-1
Volume resistivity	1E12 Ohm.m	IEC 62631-3-1
Surface resistivity	1E14 Ohm	IEC 62631-3-2
Electric strength	35 kV/mm	IEC 60243-1
Comparative tracking index	600	IEC 60112

#### Physical/Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	0.65 %	Sim. to ISO 62
Density	1370 kg/m <sup>3</sup>	ISO 1183

#### Injection

Drying Recommended	no	
Drying Temperature	100	°C
Drying Time, Dehumidified Dryer	3 - 4	h
Processing Moisture Content	≤0.2	%
Melt Temperature Optimum	200	°C
Min. melt temperature	190	°C
Max. melt temperature	210	°C
Screw tangential speed	≤0.3	m/s
Mold Temperature Optimum	100	°C
Min. mould temperature	80	°C
Max. mould temperature	120	°C
Hold pressure range	60 - 120	MPa
Back pressure	2	MPa
Ejection temperature	135	°C

#### Characteristics

Processing Injection Moulding, Other Extrusion

Delivery form Pellets

Additives Release agent

Special characteristics Low wear / Low friction

#### Additional information

Injection molding Preprocessing

General drying is not necessary due to low moisture absorption of the resin.

In case of bad storage conditions (water contact or condensed water) the use of a recirculating air dryer (100 to 120 °C / max. 40 mm

layer / 3 to 6 hours) is recommended.

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Max. Water content 0,2 %

#### **Processing**

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

#### Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes

#### **Pre-Drying**

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

#### Storage

The product can then be stored in standard conditions until processed.

#### **Automotive**

OEM STANDARD ADDITIONAL INFORMATION

Continental TST N 055 54.22

Mercedes-Benz DBL5404 BQF

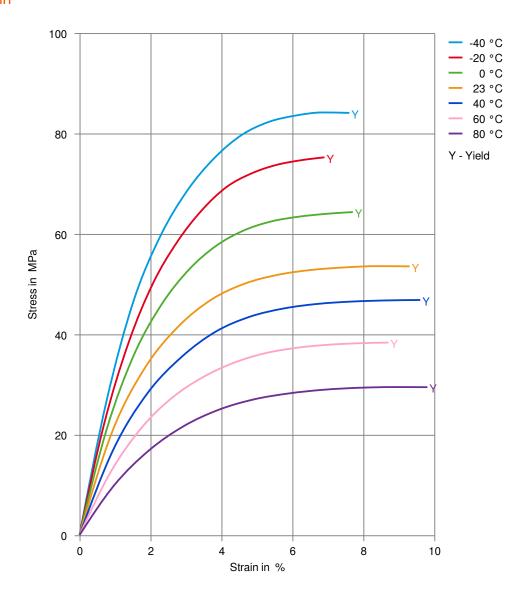
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#### Stress-strain



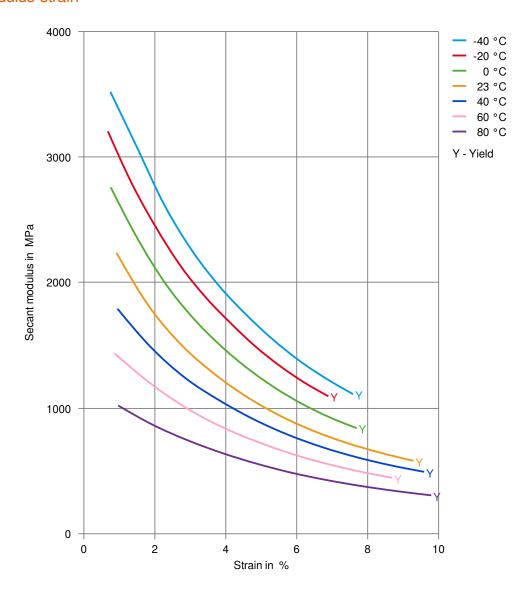
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#### Secant modulus-strain



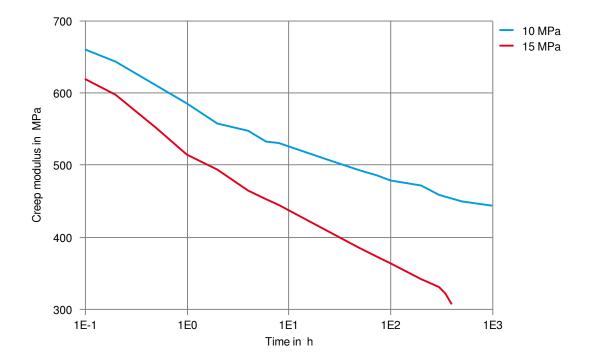
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Creep modulus-time 80°C



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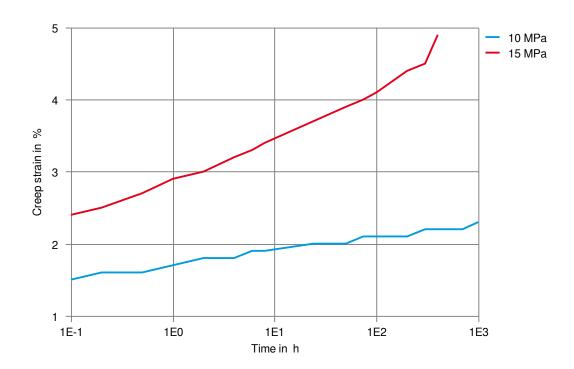
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Creep strain-time 80°C



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Revised: 2025-02-21 Source: Celanese Materials Database

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